

2SJ484

Silicon P-Channel MOS FET
High Speed Power Switching

HITACHI

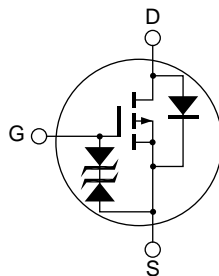
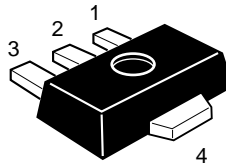
ADE-208-501A (Z)
2nd. Edition
Mar. 2001

Features

- Low on-resistance
 $R_{DS(on)} = 0.18 \Omega$ typ. (at $V_{GS} = -10V$, $I_D = -1A$)
- Low drive current
- High speed switching
- 4V gate drive devices.

Outline

UPAK



1. Gate
2. Drain
3. Source
4. Drain

Absolute Maximum Ratings ($T_a = 25^\circ\text{C}$)

Item	Symbol	Ratings	Unit
Drain to source voltage	V_{DSS}	-30	V
Gate to source voltage	V_{GSS}	± 20	V
Drain current	I_D	-2	A
Drain peak current	$I_{D(pulse)}^{*1}$	-4	A
Body to drain diode reverse drain current	I_{DR}	-2	A
Channel dissipation	Pch^{*2}	1	W
Channel temperature	Tch	150	$^\circ\text{C}$
Storage temperature	$Tstg$	-55 to +150	$^\circ\text{C}$

Notes: 1. $PW \leq 100\mu\text{s}$, duty cycle $\leq 10\%$

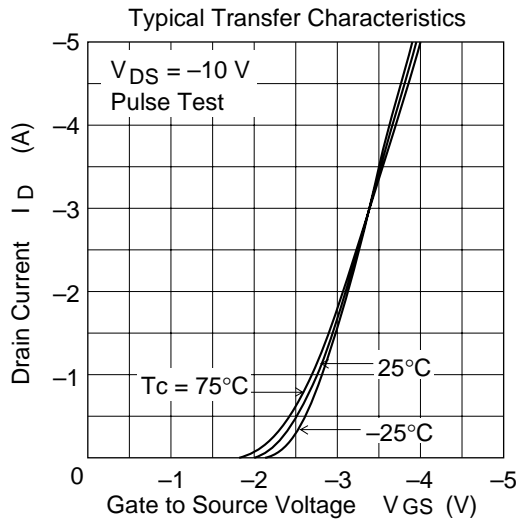
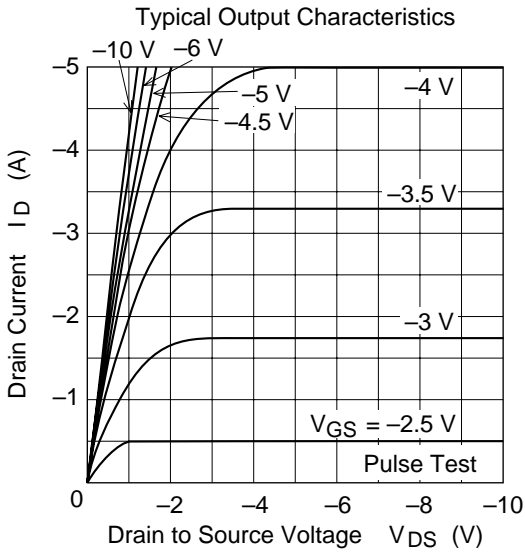
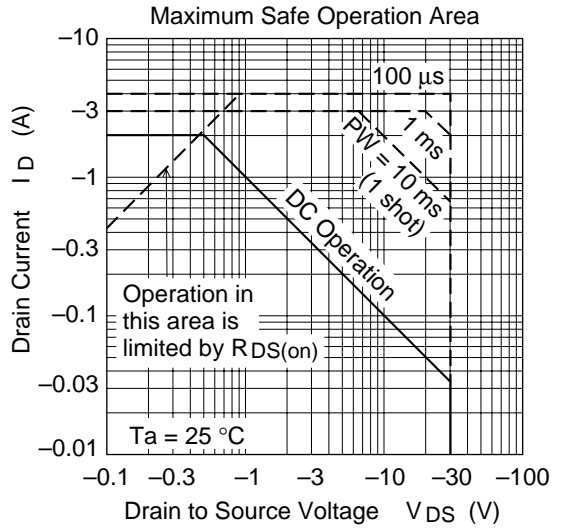
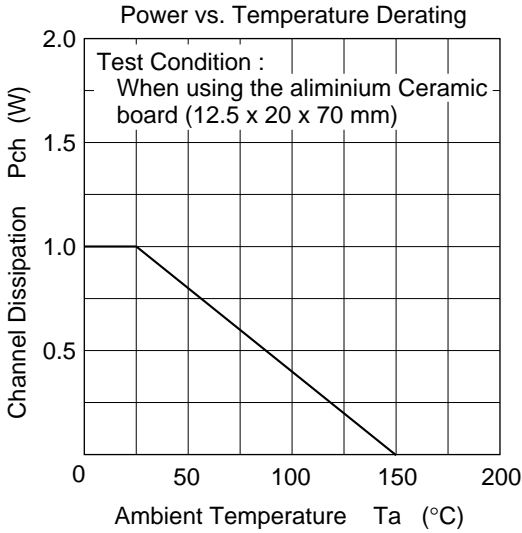
2. When using aluminium ceramic board (12.5 x 20 x 0.7 mm)

Electrical Characteristics (Ta = 25°C)

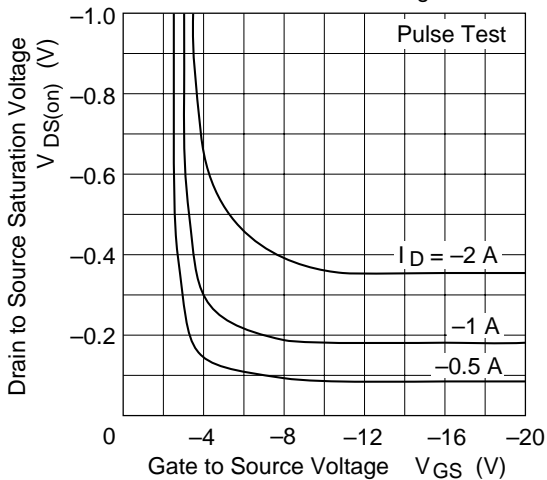
Item	Symbol	Min	Typ	Max	Unit	Test Conditions
Drain to source breakdown voltage	$V_{(BR)DSS}$	-30	—	—	V	$I_D = -10\text{mA}$, $V_{GS} = 0$
Gate to source breakdown voltage	$V_{(BR)GSS}$	±20	—	—	V	$I_G = \pm 100\mu\text{A}$, $V_{DS} = 0$
Zero gate voltage drain current	I_{DSS}	—	—	-10	μA	$V_{DS} = -30\text{V}$, $V_{GS} = 0$
Gate to source leak current	I_{GSS}	—	—	±10	μA	$V_{GS} = \pm 16\text{V}$, $V_{DS} = 0$
Gate to source cutoff voltage	$V_{GS(off)}$	-1.0	—	-2.0	V	$I_D = -1\text{mA}$, $V_{DS} = -10\text{V}$
Static drain to source on state resistance	$R_{DS(on)}$	—	0.18	0.23	Ω	$I_D = -1\text{A}$, $V_{GS} = -10\text{V}^{*1}$
	$R_{DS(on)}$	—	0.3	0.45	Ω	$I_D = -1\text{A}$, $V_{GS} = -4\text{V}^{*1}$
Forward transfer admittance	$ y_{fs} $	1.2	2.0	—	S	$I_D = -1\text{A}$, $V_{DS} = -10\text{V}^{*1}$
Input capacitance	C_{iss}	—	230	—	pF	$V_{DS} = -10\text{V}$
Output capacitance	C_{oss}	—	140	—	pF	$V_{GS} = 0$
Reverse transfer capacitance	C_{rss}	—	50	—	pF	$f = 1\text{MHz}$
Turn-on delay time	$t_{d(on)}$	—	10	—	ns	$I_D = -1\text{A}$, $R_L = 30\Omega$
Rise time	t_r	—	30	—	ns	$V_{GS} = -10\text{V}$
Turn-off delay time	$t_{d(off)}$	—	35	—	ns	
Fall time	t_f	—	30	—	ns	
Body to drain diode forward voltage	V_{DF}	—	-0.95	—	V	$I_F = -2\text{A}$, $V_{GS} = 0$
Body to drain diode reverse recovery time	t_{rr}	—	60	—	ns	$I_F = -2\text{A}$, $V_{GS} = 0$ $di_F/dt = 50\text{A}/\mu\text{s}$

- Notes: 1. Pulse test
2. Marking is "WY".

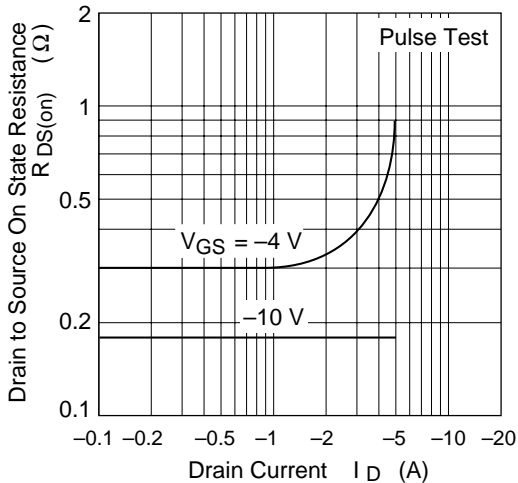
Main Characteristics



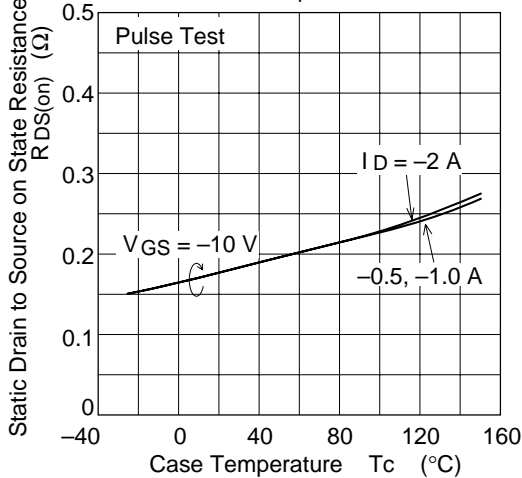
Drain to Source Saturation Voltage vs. Gate to Source Voltage



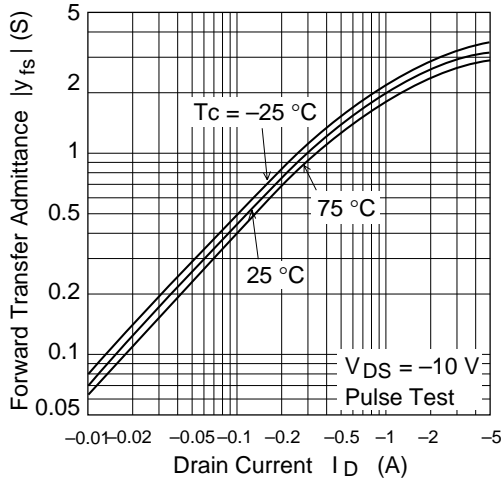
Static Drain to Source on State Resistance vs. Drain Current



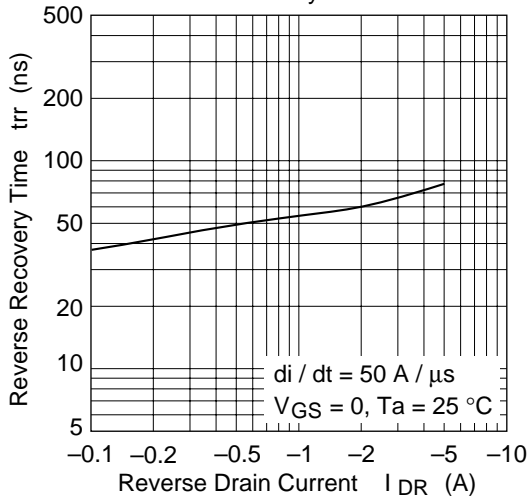
Static Drain to Source on State Resistance vs. Temperature



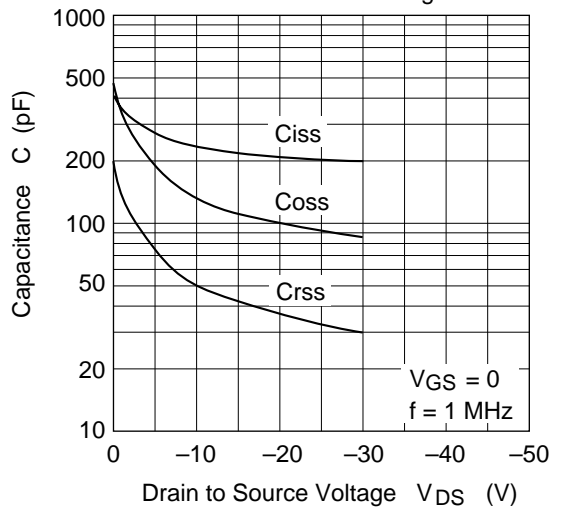
Forward Transfer Admittance vs. Drain Current



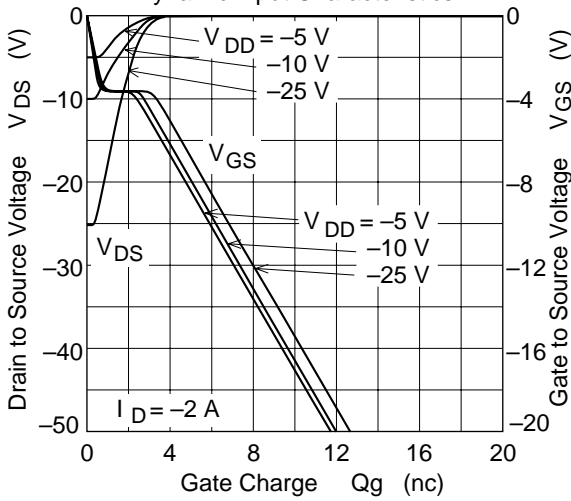
Body to Drain Diode Reverse Recovery Time



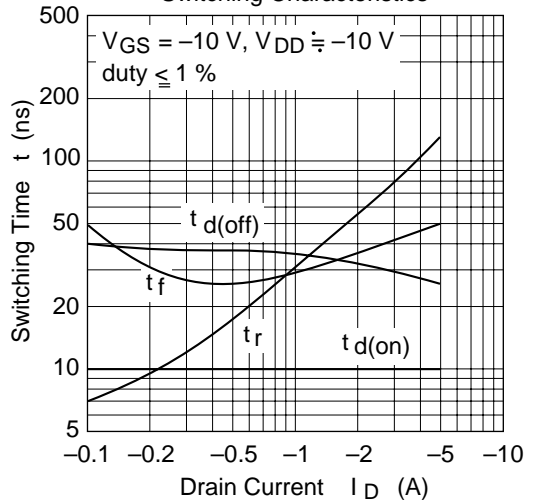
Typical Capacitance vs. Drain to Source Voltage

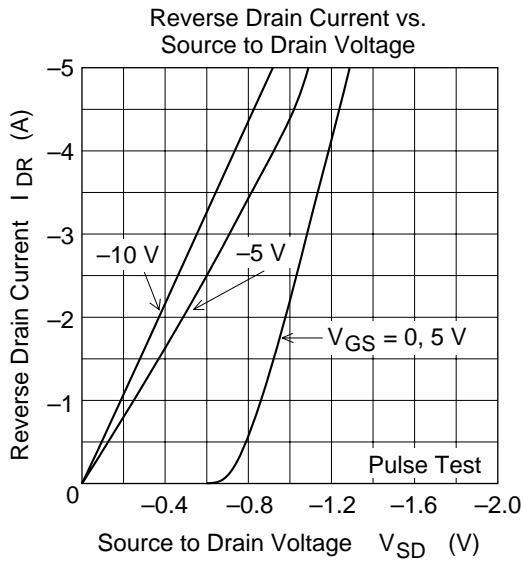


Dynamic Input Characteristics

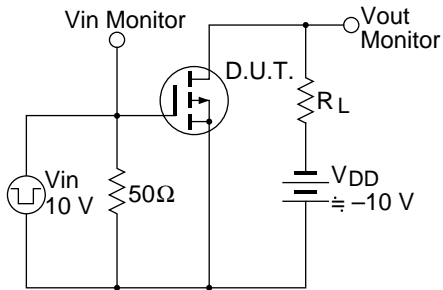


Switching Characteristics

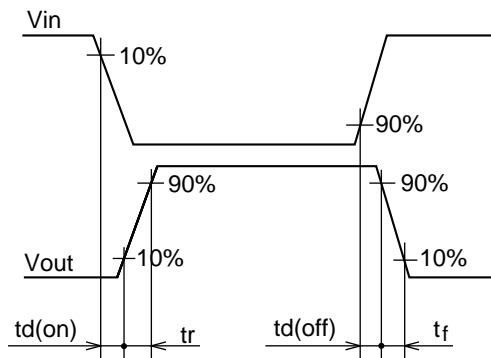




Switching Time Test Circuit

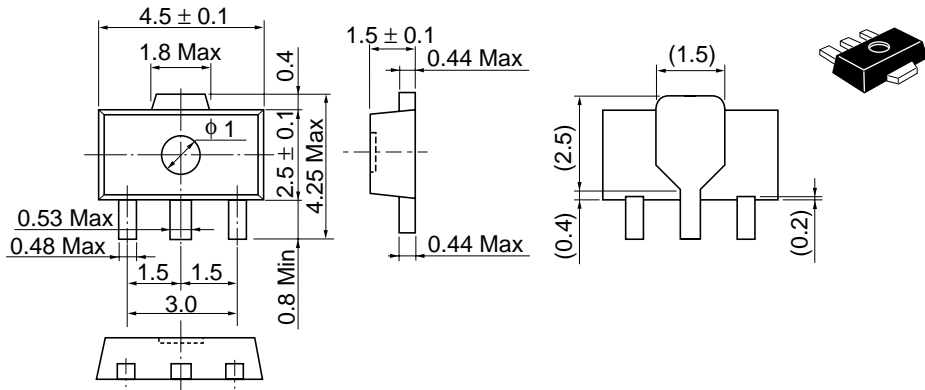


Switching Time Waveform



Package Dimensions

As of January, 2001
Unit: mm



Hitachi Code	UPAK
JEDEC	—
EIAJ	Conforms
Mass (reference value)	0.050 g

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